

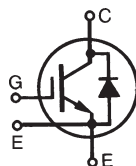
**900V XPT™ IGBT
GenX3™ w/ Diode**
IXYN80N90C3H1

$$V_{CES} = 900V$$

$$I_{C90} = 70A$$

$$V_{CE(sat)} \leq 2.7V$$

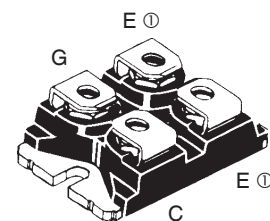
$$t_{fi(typ)} = 86ns$$

 High-Speed IGBT
for 20-50 kHz Switching


| Symbol | Test Conditions | Maximum Ratings | |
|----------------|---|-------------------------|----------------------|
| V_{CES} | $T_J = 25^\circ C$ to $150^\circ C$ | 900 | V |
| V_{CGR} | $T_J = 25^\circ C$ to $150^\circ C$, $R_{GE} = 1M\Omega$ | 900 | V |
| V_{GES} | Continuous | ± 20 | V |
| V_{GEM} | Transient | ± 30 | V |
| I_{C25} | $T_C = 25^\circ C$ | 115 | A |
| I_{C90} | $T_C = 90^\circ C$ | 70 | A |
| I_{F110} | $T_C = 110^\circ C$ | 42 | A |
| I_{CM} | $T_C = 25^\circ C$, 1ms | 340 | A |
| SSOA | $V_{GE} = 15V$, $T_{VJ} = 150^\circ C$, $R_G = 2\Omega$ | $I_{CM} = 160$ | A |
| (RBSOA) | Clamped Inductive Load | @ $V_{CE} \leq V_{CES}$ | |
| P_C | $T_C = 25^\circ C$ | 500 | W |
| T_J | | -55 ... +150 | $^\circ C$ |
| T_{JM} | | 150 | $^\circ C$ |
| T_{stg} | | -55 ... +150 | $^\circ C$ |
| V_{ISOL} | 50/60Hz $t = 1min$ $I_{ISOL} \leq 1mA$ $t = 1s$ | 2500 3000 | V~ V~ |
| M_d | Mounting Torque Terminal Connection Torque | 1.5/13 1.3/11.5 | Nm/lb.in Nm/lb.in |
| Weight | | 30 | g |

SOT-227B, miniBLOC

E153432



G = Gate, C = Collector, E = Emitter
 ① either emitter terminal can be used as
 Main or Kelvin Emitter

Features

- Optimized for Low Switching Losses
- Square RBSOA
- Isolation Voltage 2500V~
- Anti-Parallel Sonic Diode
- Positive Thermal Coefficient of $V_{ce(sat)}$
- High Current Handling Capability
- International Standard Package

Advantages

- High Power Density
- Low Gate Drive Requirement

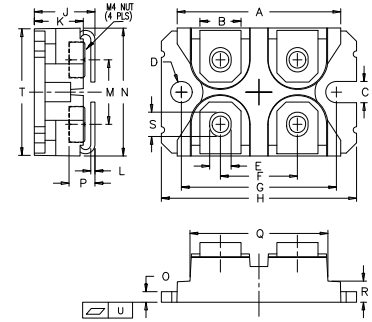
Applications

- High Frequency Power Inverters
- UPS
- Motor Drives
- SMPS
- PFC Circuits
- Battery Chargers
- Welding Machines
- Lamp Ballasts

| Symbol | Test Conditions ($T_J = 25^\circ C$, Unless Otherwise Specified) | Characteristic Values | | |
|---------------|---|-----------------------|------------|----------------------|
| | | Min. | Typ. | Max. |
| BV_{CES} | $I_C = 250\mu A$, $V_{GE} = 0V$ | 950 | | V |
| $V_{GE(th)}$ | $I_C = 250\mu A$, $V_{CE} = V_{GE}$ | 3.5 | | 5.5 V |
| I_{CES} | $V_{CE} = V_{CES}$, $V_{GE} = 0V$ $T_J = 125^\circ C$ | | | 25 μA 1.5 mA |
| I_{GES} | $V_{CE} = 0V$, $V_{GE} = \pm 20V$ | | | ± 100 nA |
| $V_{CE(sat)}$ | $I_C = 60A$, $V_{GE} = 15V$, Note 1 $T_J = 125^\circ C$ | | 2.3 2.9 | 2.7 V V |

| Symbol | Test Conditions ($T_J = 25^\circ\text{C}$ Unless Otherwise Specified) | Characteristic Values | | |
|--------------|---|-----------------------|------|--------------------|
| | | Min. | Typ. | Max. |
| g_{fs} | $I_C = 60\text{A}, V_{CE} = 10\text{V}$, Note 1 | 23 | 38 | S |
| C_{ies} | $V_{CE} = 25\text{V}, V_{GE} = 0\text{V}, f = 1\text{MHz}$ | | 4550 | pF |
| C_{oes} | | | 243 | pF |
| C_{res} | | | 77 | pF |
| $Q_{g(on)}$ | $I_C = 80\text{A}, V_{GE} = 15\text{V}, V_{CE} = 0.5 \cdot V_{CES}$ | | 145 | nC |
| Q_{ge} | | | 42 | nC |
| Q_{gc} | | | 65 | nC |
| $t_{d(on)}$ | Inductive load, $T_J = 25^\circ\text{C}$ $I_C = 80\text{A}, V_{GE} = 15\text{V}$ $V_{CE} = 0.5 \cdot V_{CES}, R_G = 2\Omega$ Note 2 | | 34 | ns |
| t_{ri} | | | 103 | ns |
| E_{on} | | | 4.3 | mJ |
| $t_{d(off)}$ | | | 90 | ns |
| t_{fi} | | | 86 | ns |
| E_{off} | | | 1.9 | 2.7 mJ |
| $t_{d(on)}$ | Inductive load, $T_J = 150^\circ\text{C}$ $I_C = 80\text{A}, V_{GE} = 15\text{V}$ $V_{CE} = 0.5 \cdot V_{CES}, R_G = 2\Omega$ Note 2 | | 34 | ns |
| t_{ri} | | | 100 | ns |
| E_{on} | | | 5.7 | mJ |
| $t_{d(off)}$ | | | 103 | ns |
| t_{fi} | | | 98 | ns |
| E_{off} | | | 2.5 | mJ |
| R_{thJC} | | | 0.25 | $^\circ\text{C/W}$ |
| R_{thCS} | | 0.05 | | $^\circ\text{C/W}$ |

SOT-227B miniBLOC (IXYN)



| SYM | INCHES | | MILLIMETERS | |
|-----|--------|-------|-------------|-------|
| | MIN | MAX | MIN | MAX |
| A | 1.240 | 1.255 | 31.50 | 31.88 |
| B | .307 | .323 | 7.80 | 8.20 |
| C | .161 | .169 | 4.09 | 4.29 |
| D | .161 | .169 | 4.09 | 4.29 |
| E | .161 | .169 | 4.09 | 4.29 |
| F | .587 | .595 | 14.91 | 15.11 |
| G | 1.186 | 1.193 | 30.12 | 30.30 |
| H | 1.496 | 1.505 | 38.00 | 38.23 |
| J | .460 | .481 | 11.68 | 12.22 |
| K | .351 | .378 | 8.92 | 9.60 |
| L | .030 | .033 | 0.76 | 0.84 |
| M | .496 | .506 | 12.60 | 12.85 |
| N | .990 | 1.001 | 25.15 | 25.42 |
| O | .078 | .084 | 1.98 | 2.13 |
| P | .195 | .235 | 4.95 | 5.97 |
| Q | 1.045 | 1.059 | 26.54 | 26.90 |
| R | .155 | .174 | 3.94 | 4.42 |
| S | .186 | .191 | 4.72 | 4.85 |
| T | .968 | .987 | 24.59 | 25.07 |
| U | -.002 | .004 | -0.05 | 0.1 |

Reverse Sonic Diode (FRD)

| Symbol | Test Conditions ($T_J = 25^\circ\text{C}$, Unless Otherwise Specified) | Characteristic Values | | |
|------------|--|-----------------------|------|-------------------------|
| | | Min. | Typ. | Max. |
| V_F | $I_F = 60\text{A}, V_{GE} = 0\text{V}$, Note 1 $T_J = 125^\circ\text{C}$ | | 1.9 | 2.7 V |
| I_{RM} | $I_F = 60\text{A}, V_{GE} = 0\text{V}, T_J = 125^\circ\text{C}$ $-di_F/dt = 700\text{A}/\mu\text{s}, V_R = 600\text{V}$ | | 41 | A |
| t_{rr} | | | 420 | ns |
| R_{thJC} | | | | 0.42 $^\circ\text{C/W}$ |

Notes:

1. Pulse test, $t \leq 300\mu\text{s}$, duty cycle, $d \leq 2\%$.
2. Switching times & energy losses may increase for higher V_{CE} (clamp), T_J or R_G .

PRELIMINARY TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

IXYS MOSFETs and IGBTs are covered 4,835,592 4,931,844 5,049,961 5,237,481 6,162,665 6,404,065 B1 6,683,344 6,727,585 7,005,734 B2 7,157,338B2
by one or more of the following U.S. patents: 4,860,072 5,017,508 5,063,307 5,381,025 6,259,123 B1 6,534,343 6,710,405 B2 6,759,692 7,063,975 B2
4,881,106 5,034,796 5,187,117 5,486,715 6,306,728 B1 6,583,505 6,710,463 6,771,478 B2 7,071,537

Fig. 1. Output Characteristics @ $T_J = 25^\circ\text{C}$

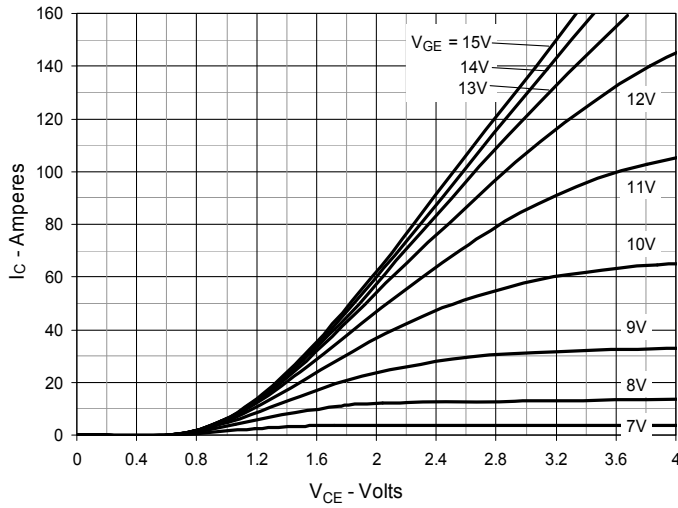


Fig. 2. Extended Output Characteristics @ $T_J = 25^\circ\text{C}$

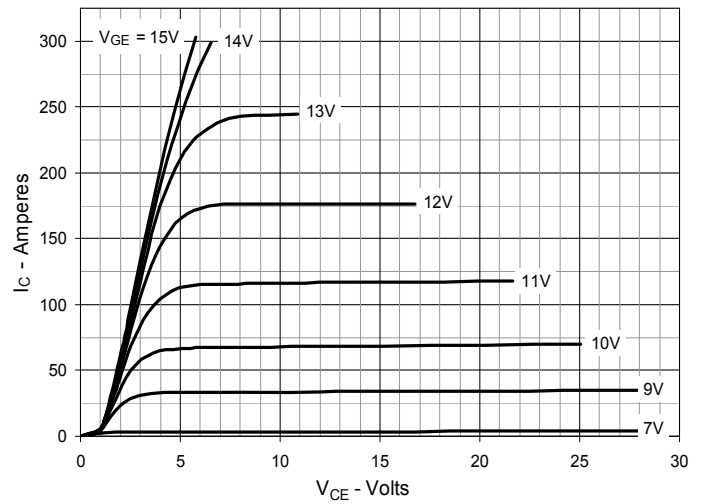


Fig. 3. Output Characteristics @ $T_J = 150^\circ\text{C}$

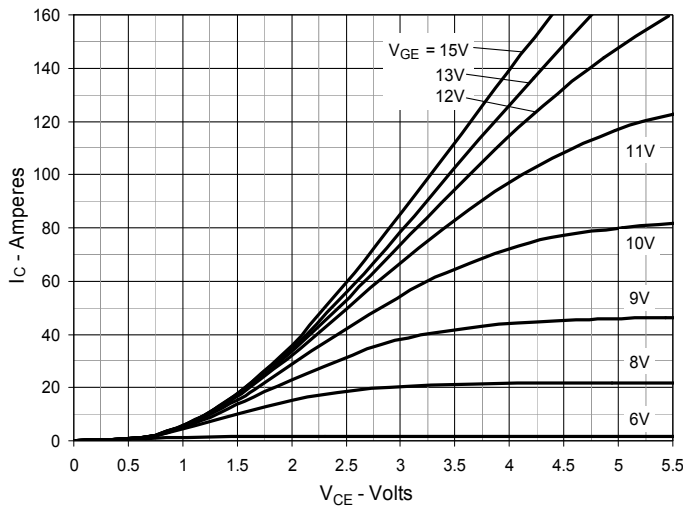


Fig. 4. Dependence of $V_{CE(sat)}$ on Junction Temperature

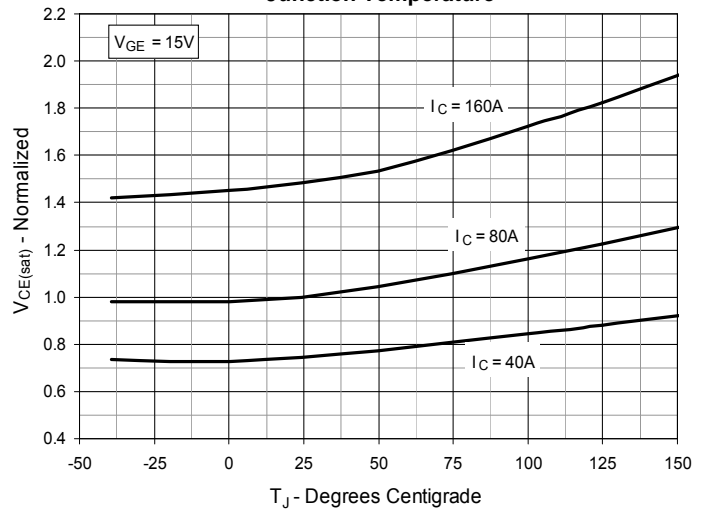


Fig. 5. Collector-to-Emitter Voltage vs. Gate-to-Emitter Voltage

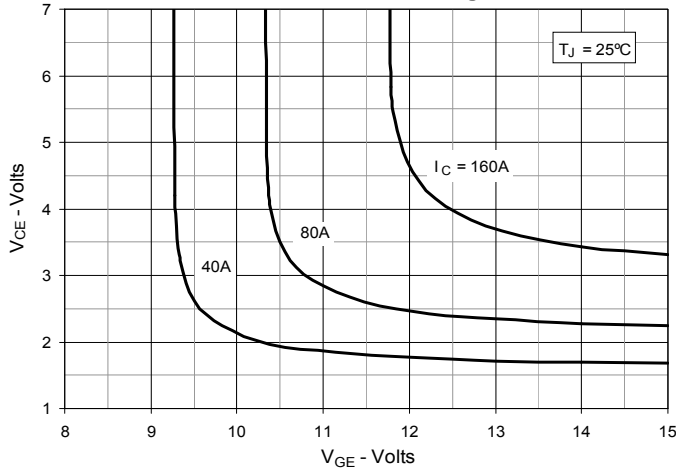


Fig. 6. Input Admittance

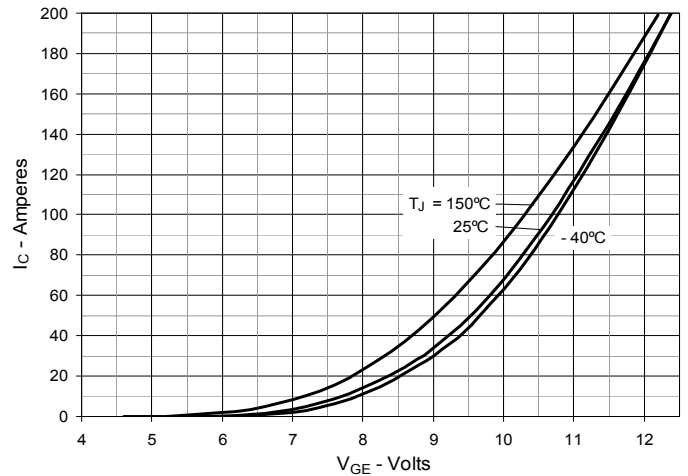


Fig. 7. Transconductance

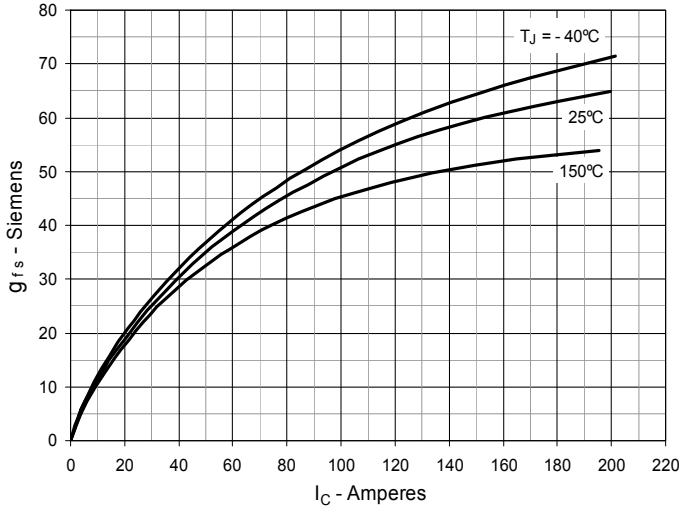


Fig. 8. Gate Charge

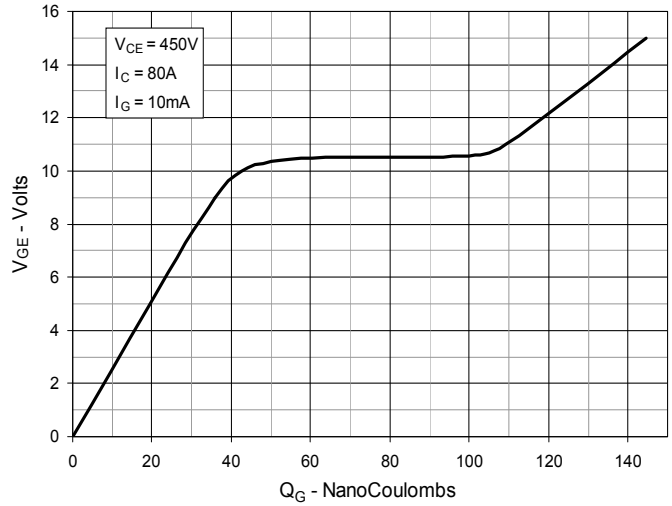


Fig. 9. Capacitance

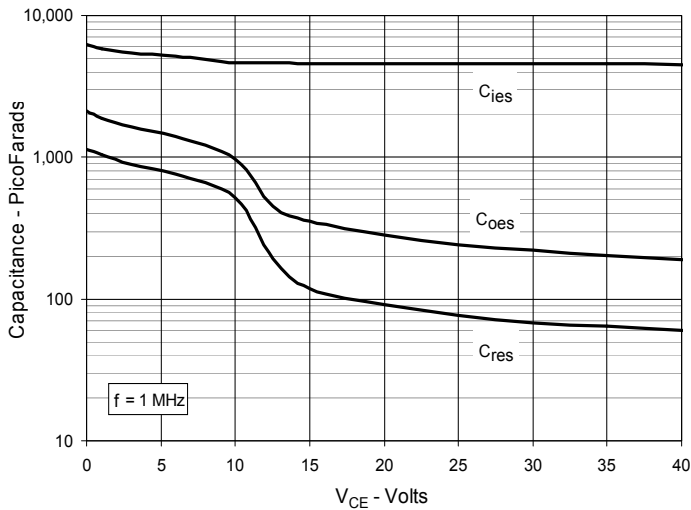


Fig. 10. Reverse-Bias Safe Operating Area

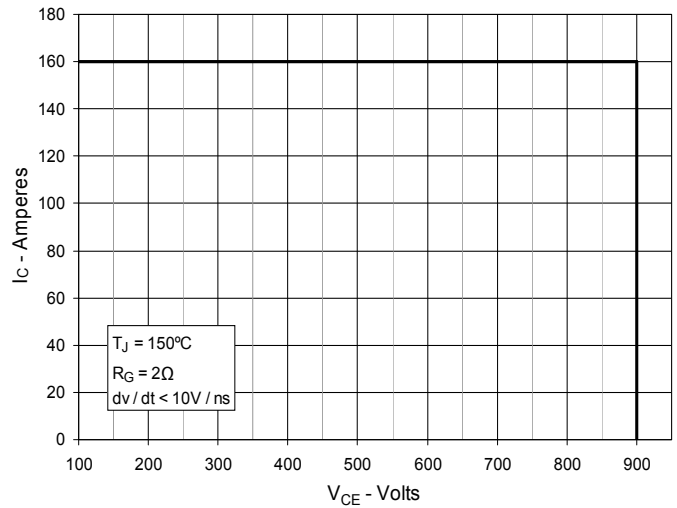


Fig. 11. Maximum Transient Thermal Impedance

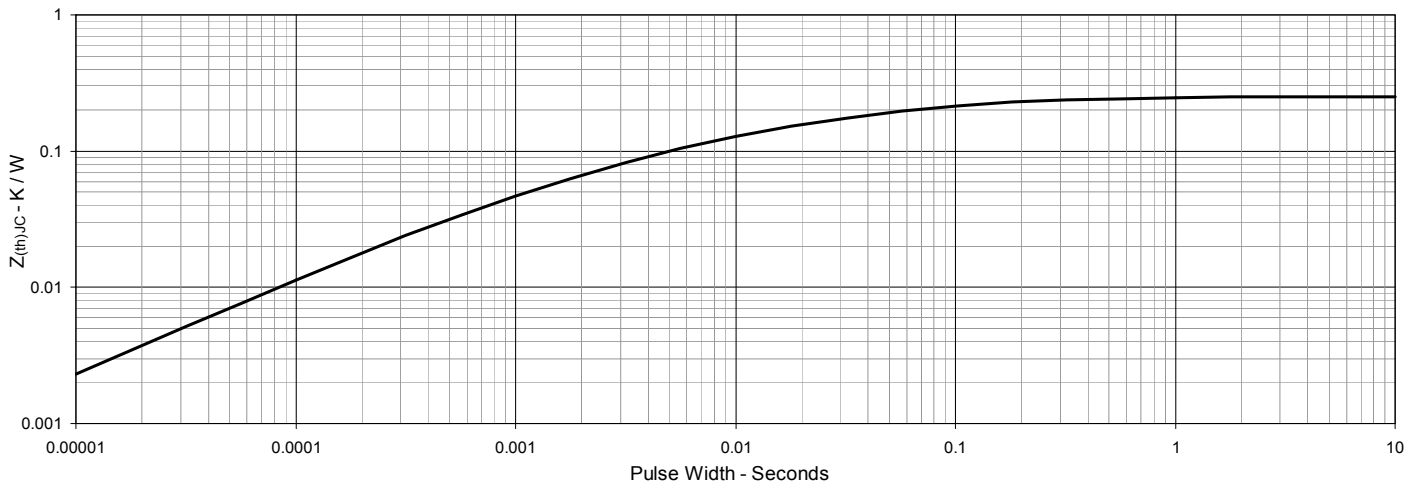


Fig. 12. Inductive Switching Energy Loss vs. Gate Resistance

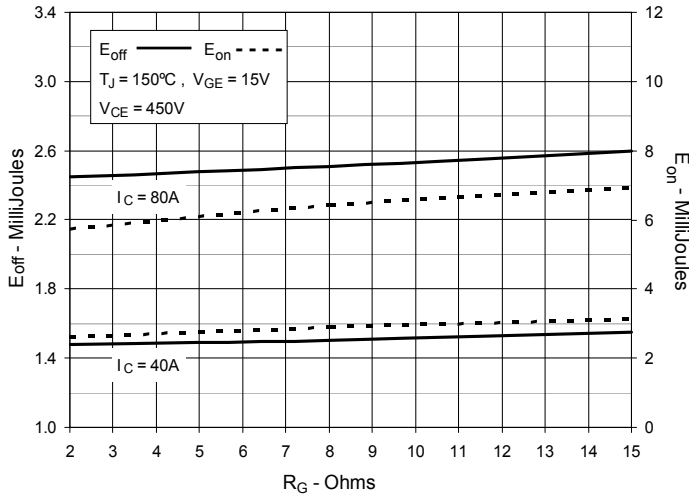


Fig. 13. Inductive Switching Energy Loss vs. Collector Current

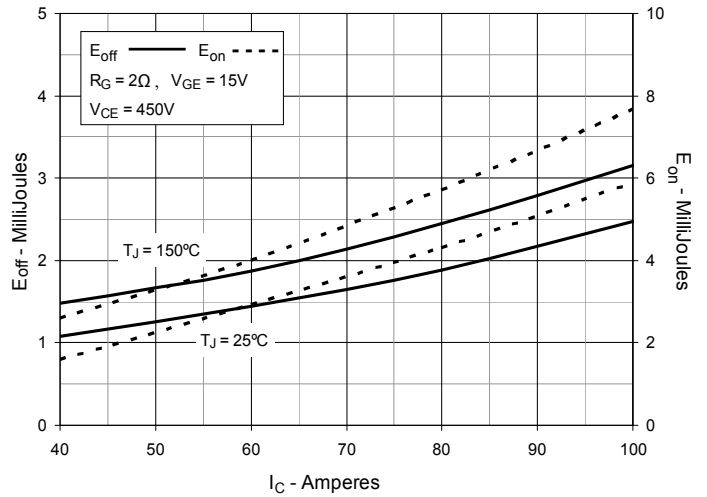


Fig. 14. Inductive Switching Energy Loss vs. Junction Temperature

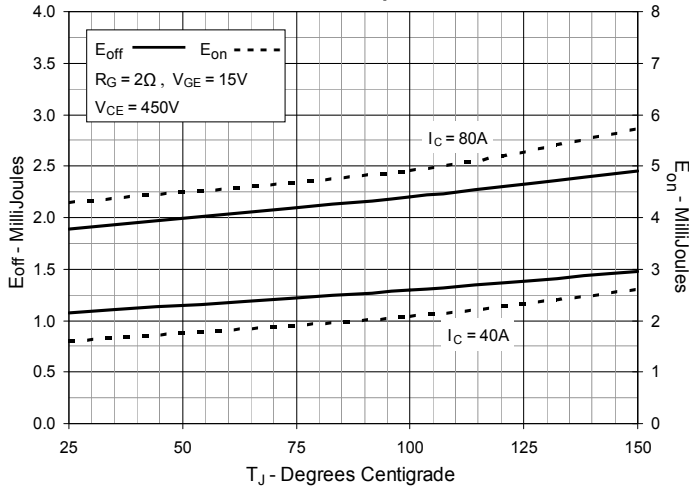


Fig. 15. Inductive Turn-off Switching Times vs. Gate Resistance

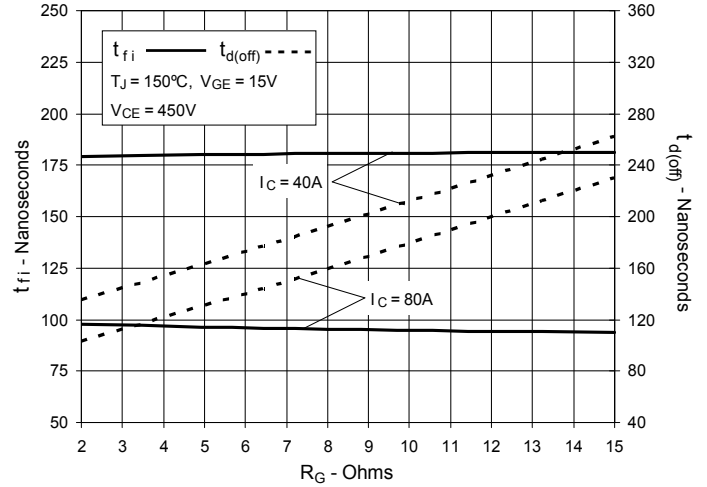


Fig. 16. Inductive Turn-off Switching Times vs. Collector Current

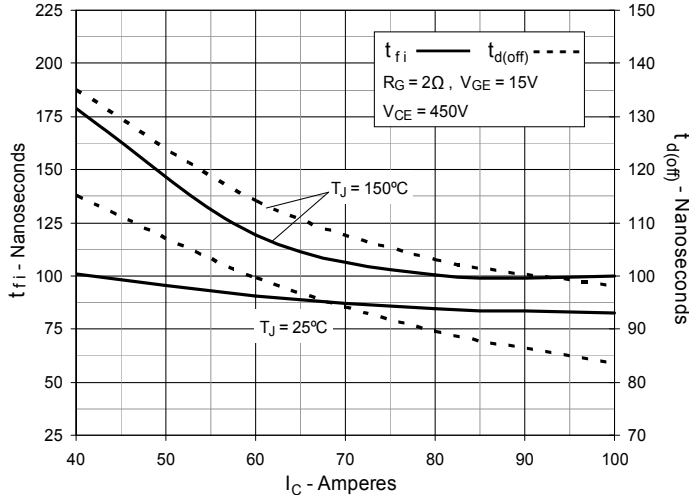


Fig. 17. Inductive Turn-off Switching Times vs. Junction Temperature

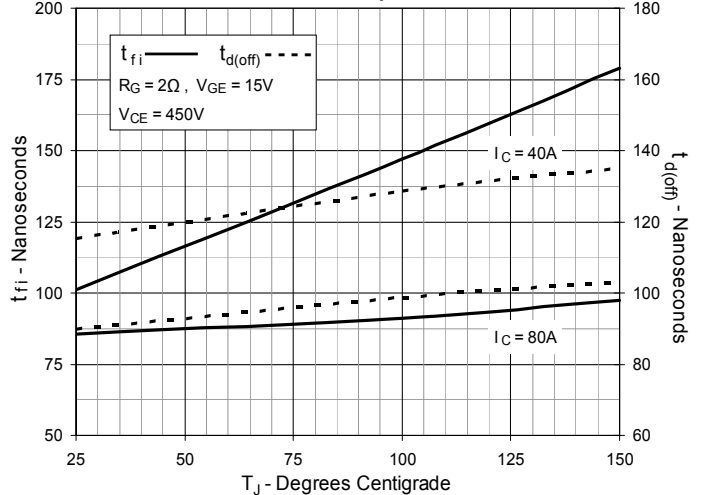


Fig. 18. Inductive Turn-on Switching Times vs. Gate Resistance

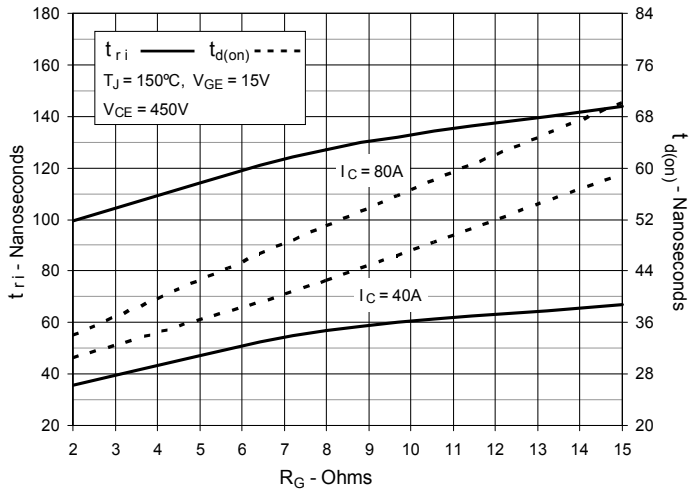


Fig. 19. Inductive Turn-on Switching Times vs. Collector Current

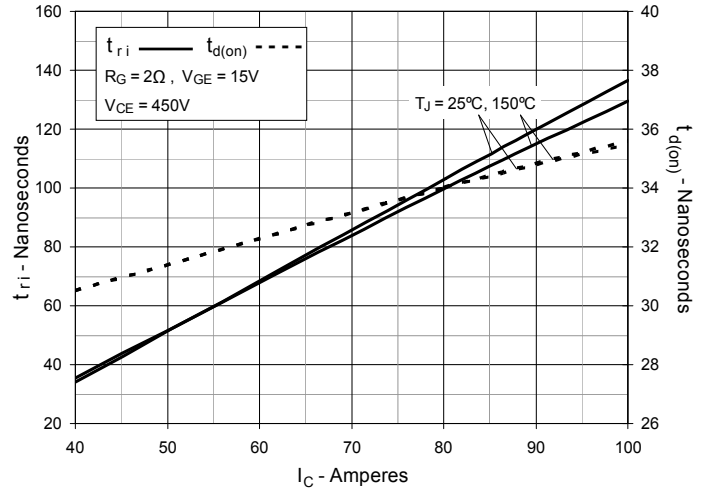


Fig. 20. Inductive Turn-on Switching Times vs. Junction Temperature

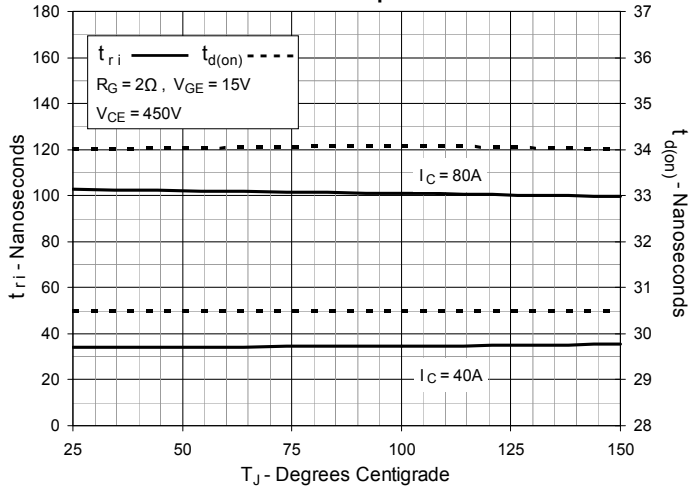
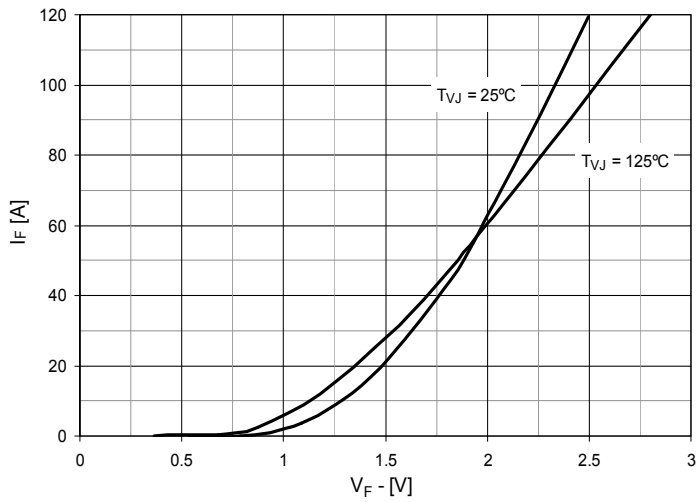
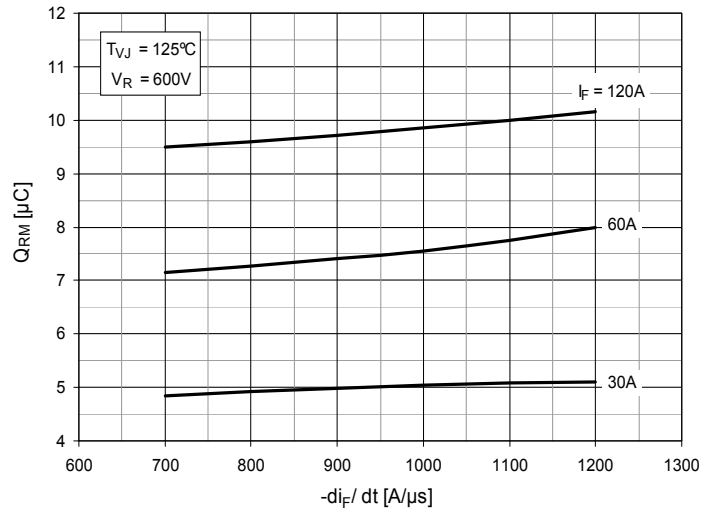
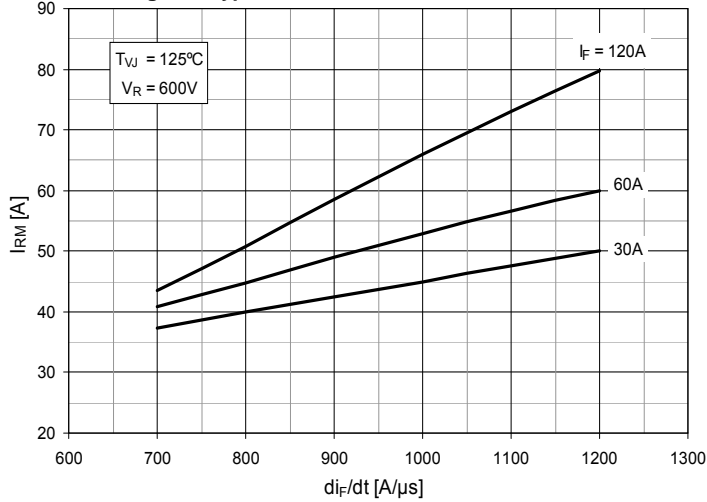
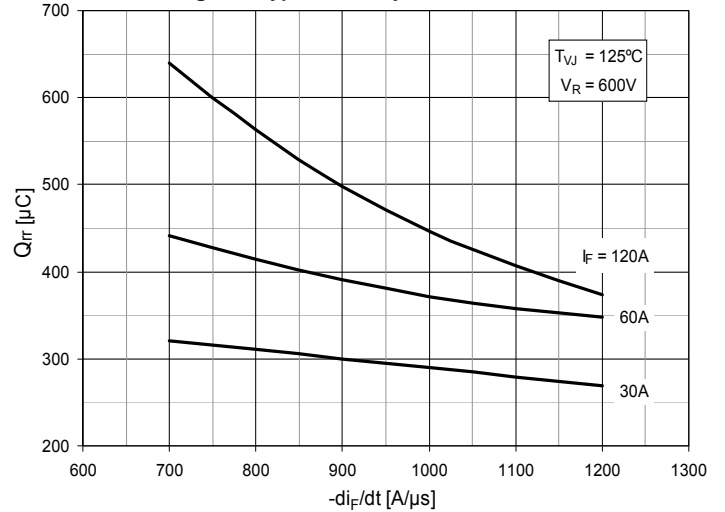
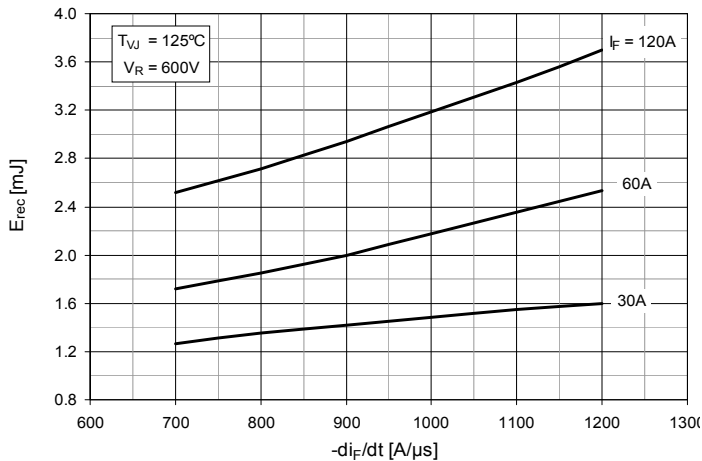
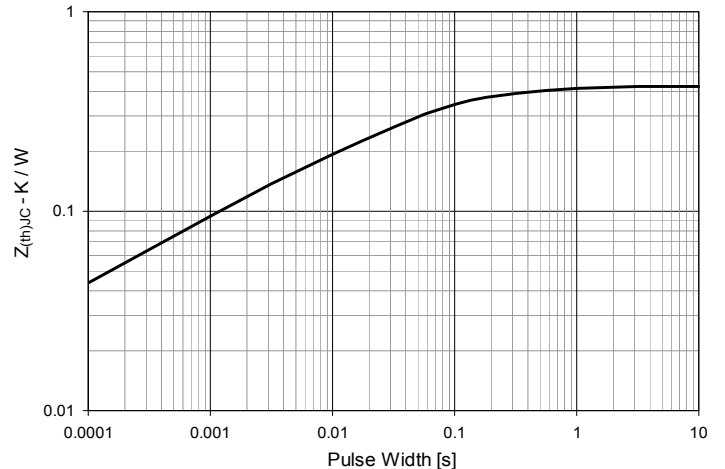


Fig. 21. Typ. Forward characteristics

Fig. 22. Typ. Reverse Recovery Charge Q_{rr} vs. $-di_F/dt$

Fig. 23. Typ. Peak Reverse Current I_{RM} vs. $-di_F/dt$

Fig. 24. Typ. Recovery Time t_{rr} vs. $-di_F/dt$

Fig. 25. Typ. Recovery Energy E_{rec} vs. $-di_F/dt$

Fig. 26. Maximum Transient Thermal Impedance (Diode)




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